

PROTECTION PRODUCTS - RailClamp®

Description

RailClamp® TVS arrays are ultra low capacitance ESD protection devices designed to protect high speed data interfaces. They are designed to replace 0201 size multilayer varistors (MLVs) in portable applications such as cell phones, notebook computers, and other portable electronics. This device offers desirable characteristics for board level protection including fast response time, low operating and clamping voltage, and no device degradation.

The RClamp®0552T has a maximum capacitance of only 0.40pF. This allows it to be used on circuits operating in excess of 5GHz without signal attenuation.

The RClamp0552T is in a 3-pin SLP1006N3T package. It measures 1.0 x 0.6 mm with a nominal height of only 0.4mm. The leads are finished with lead-free NiPdAu. Each device will protect two lines operating at 5 volts. It gives the designer the flexibility to replace multiple single line devices in space constrained applications. They may be used to meet the ESD immunity requirements of IEC 61000-4-2. The combination of small size and high ESD surge capability makes them ideal for use in portable applications such as cellular phones, digital cameras, and MP3 players.

Features

- ◆ High ESD withstand Voltage: +/-**17kV** (Contact and Air) per **IEC 61000-4-2**
- ◆ Very small PCB area: 0.6mm²
- ◆ Protects up to two high-speed data lines
- ◆ Low reverse current: <5nA typical (VR=5V)
- ◆ Working voltage: +/- 5V
- ◆ Low capacitance: <0.4pF (VR=0V)
- ◆ Low dynamic resistance: 0.90 Ohms (Typ)
- ◆ Solid-state silicon-avalanche technology

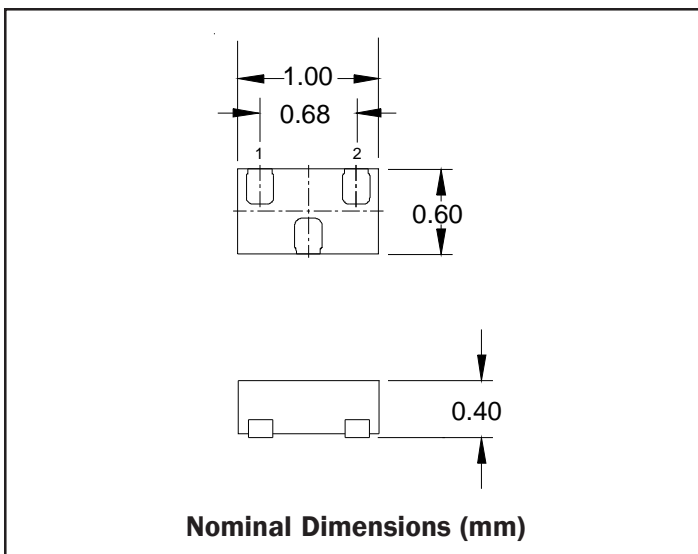
Mechanical Characteristics

- ◆ SLP1006N3T package
- ◆ Pb-Free, Halogen Free, RoHS/WEEE Compliant
- ◆ Nominal Dimensions: 1.0 x 0.6 x 0.40 mm
- ◆ Lead Finish: NiPdAu
- ◆ Molding compound flammability rating: UL 94V-0
- ◆ Marking : Marking code + dot matrix date code
- ◆ Packaging : Tape and Reel

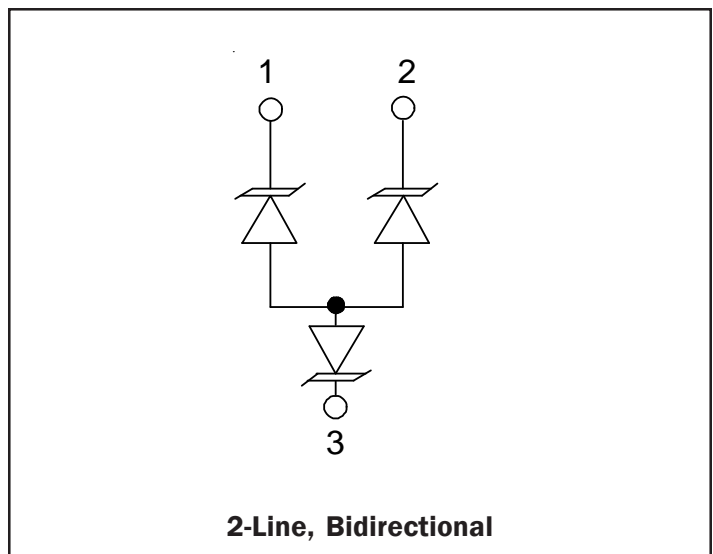
Applications

- ◆ HDMI 1.3 and HDMI 1.4
- ◆ USB 3.0
- ◆ MHL
- ◆ eDP
- ◆ LVDS Interfaces
- ◆ eSATA Interfaces

Dimensions



Schematic & PIN Configuration



PROTECTION PRODUCTS
Absolute Maximum Rating

Rating	Symbol	Value	Units
Peak Pulse Power (tp = 8/20μs)	P_{pk}	60	Watts
Maximum Peak Pulse Current (tp = 8/20μs)	I_{pp}	3	Amps
ESD per IEC 61000-4-2 (Air) ¹ ESD per IEC 61000-4-2 (Contact) ¹	V_{ESD}	+/- 17 +/- 17	kV
Operating Temperature	T_J	-55 to +125	°C
Storage Temperature	T_{STG}	-55 to +150	°C

Electrical Characteristics (T=25°C)

Parameter	Symbol	Conditions	Minimum	Typical	Maximum	Units
Reverse Stand-Off Voltage	V_{RWM}	Any I/O Pin to GND			5	V
Reverse Breakdown Voltage	V_{BR}	$I_t = 1mA$ Any I/O Pin to GND	6.5	9	11	V
Reverse Leakage Current	I_R	$V_{RWM} = 2V, T=25°C$ Any I/O Pin to GND		<5	20	nA
Reverse Leakage Current	I_R	$V_{RWM} = 5V, T=25°C$ Any I/O Pin to GND		<55	100	nA
Clamping Voltage	V_C	$I_{pp} = 3A, tp = 8/20μs$ Any I/O Pin to GND			20	V
ESD Clamping Voltage ²	V_C	$I_{pp} = 16A,$ $t_{lp} = 0.2/100ns$		24.5		V
Dynamic Resistance ^{2, 3}	R_{Dyn}	$tp = 100ns$		0.90		Ohms
Junction Capacitance	C_j	$V_R = 0V, f = 1MHz$ Any I/O Pin to GND		0.21	0.4	pF

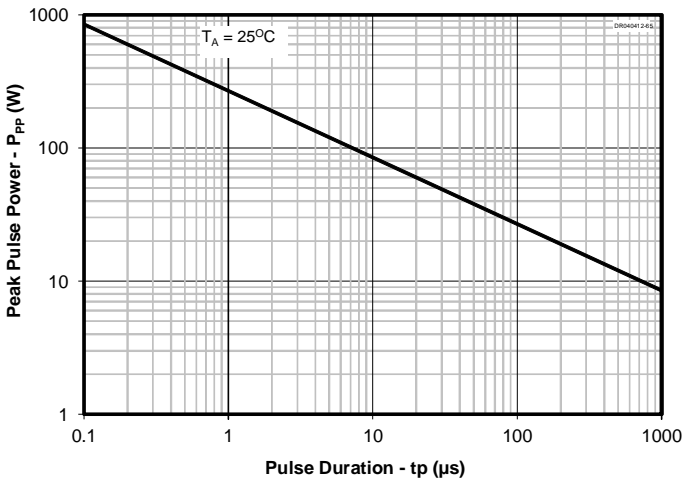
Notes

- 1)ESD gun return path connected to ESD ground reference plane.
- 2)Transmission Line Pulse Test (TLP) Settings: $t_p = 100ns, t_r = 0.2ns, I_{TLP}$ and V_{TLP} averaging window: $t_1 = 70ns$ to $t_2 = 90ns$.
- 3) Dynamic resistance calculated from $I_{TLP} = 4A$ to $I_{TLP} = 16A$
- 4)Guaranteed by design. Not production tested

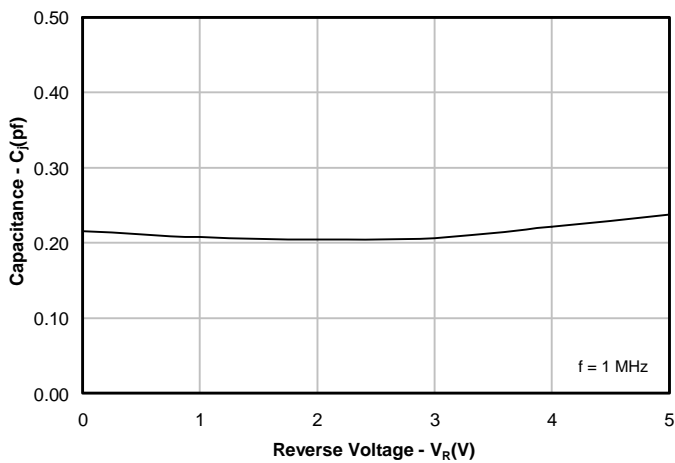
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Typical Characteristics

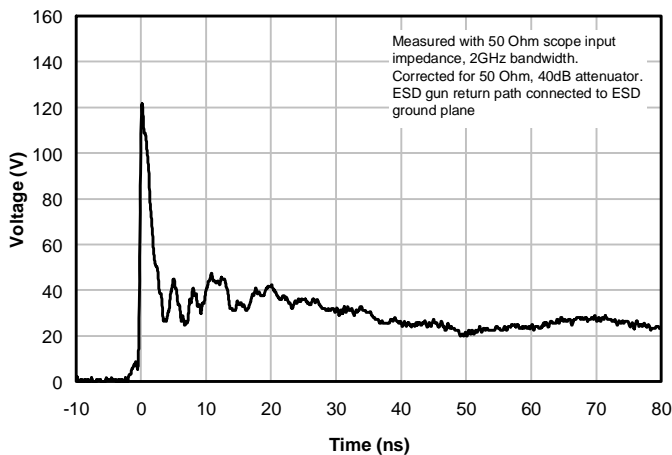
Non-Repetitive Peak Pulse Power vs. Pulse Time



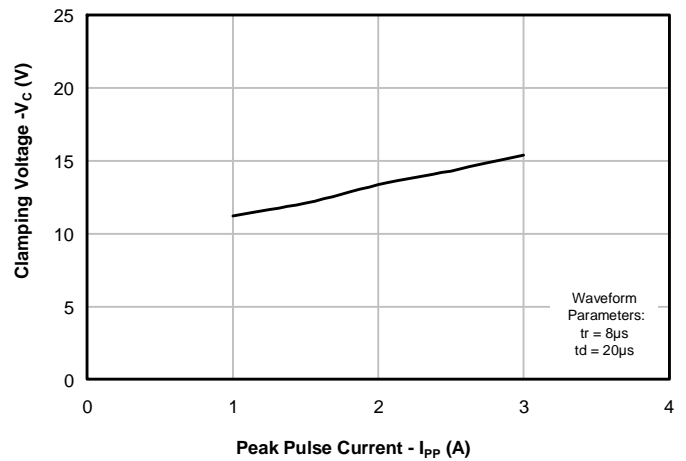
Junction Capacitance vs. Reverse Voltage



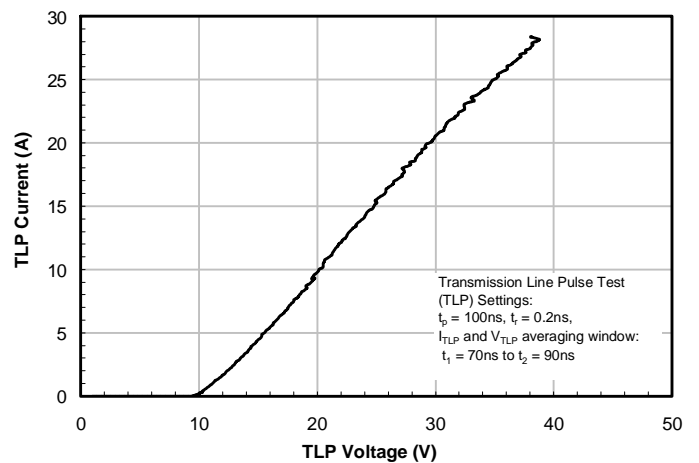
ESD Clamping (+8kV Contact per IEC 61000-4-2)



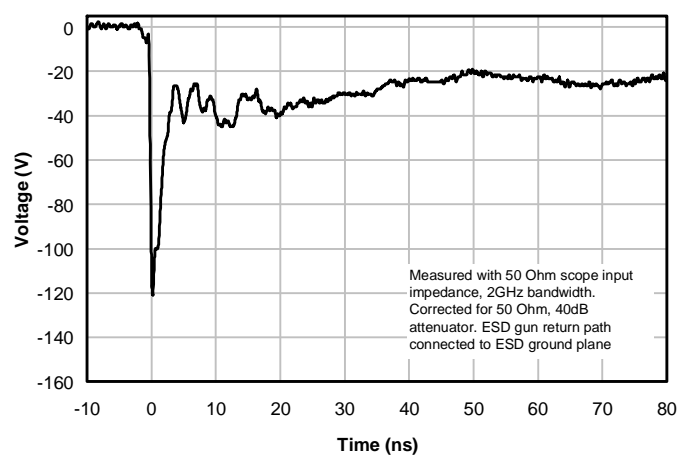
Clamping Voltage vs. Peak Pulse Current ($t_p=8/20\mu$ s)

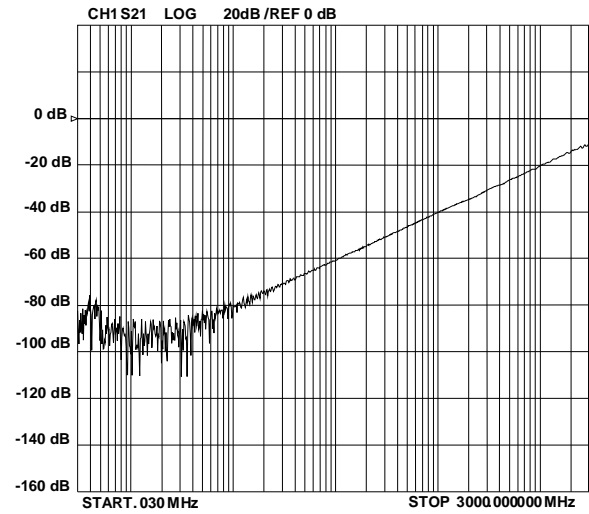
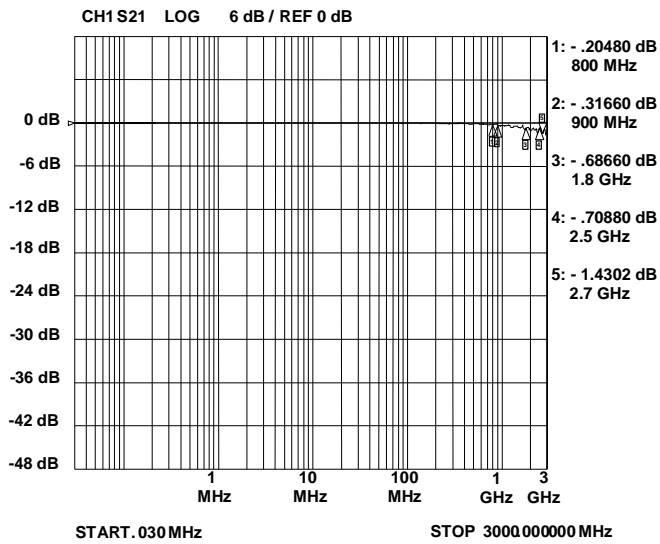


TLP Characteristic



ESD Clamping (-8kV Contact per IEC 61000-4-2)



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Typical Characteristics
Typical Insertion Loss S21
Analog Crosstalk


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Applications Information

Device Connection Options

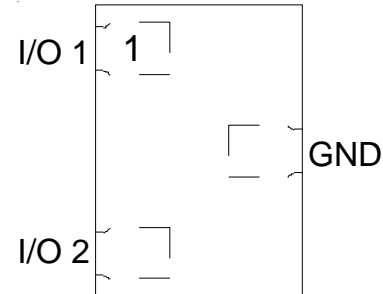
The RClamp0552T is designed to protect two high-speed data lines operating up to 5 volts. The device is bidirectional and may be used on lines where the signal polarity is above and below ground. The diagram at the right shows an example pin configuration with pin 3 connected to ground. However, due to the device symmetry, any pin may be connected to ground with the remaining pins connected to the protected lines.

Assembly Guidelines

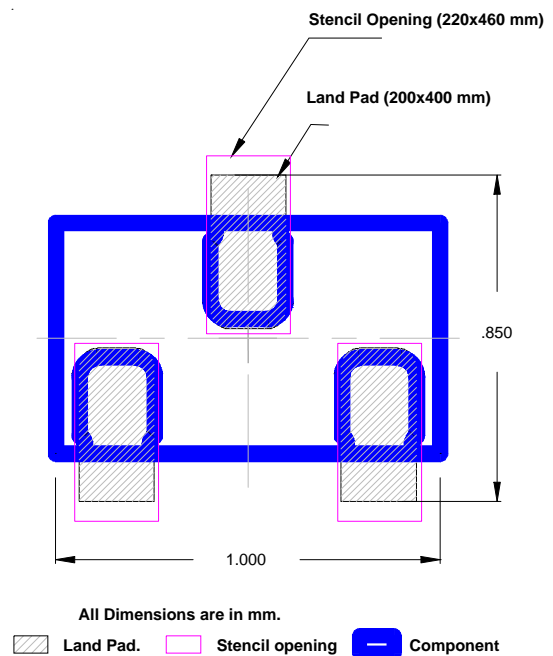
The small size of this device means that some care must be taken during the mounting process to insure reliable solder joint. The table below provides Semtech's recommended assembly guidelines for mounting this device. The figure at the right details Semtech's recommended aperture based on the below recommendations. Note that these are only recommendations and should serve only as a starting point for design since there are many factors that affect the assembly process. The exact manufacturing parameters will require some experimentation to get the desired solder application.

Assembly Parameter	Recommendation
Solder Stencil Design	Laser cut, Electro-polished
Aperture shape	Rectangular
Solder Stencil Thickness	0.100 mm (0.004")
Solder Paste Type	Type 4 size sphere or smaller
Solder Reflow Profile	Per JEDEC J-STD-020
PCB Solder Pad Design	Non-Solder mask defined
PCB Pad Finish	OSP OR NiAu

Example Pin Configuration

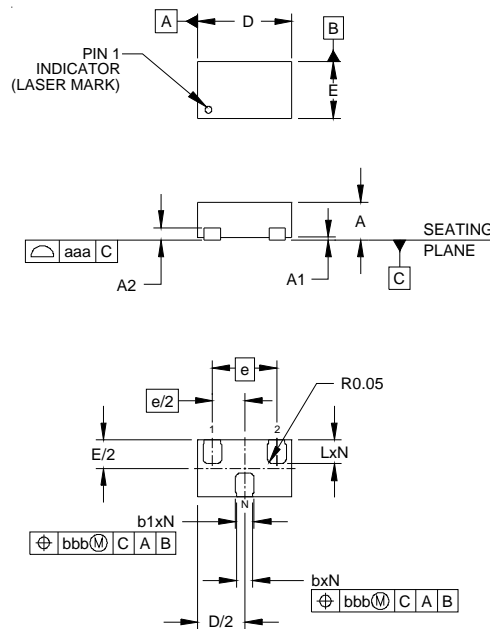


Recommended Mounting Pattern



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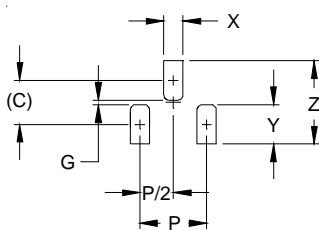
Outline Drawing - SLP1006N3T



DIM	MILLIMETERS		
	MIN	NOM	MAX
A	0.37	0.40	0.43
A1	0.00	0.02	0.05
A2	(0.13)		
b	0.145	0.17	0.195
b1	0.175	0.20	0.225
D	0.90	1.00	1.10
E	0.50	0.60	0.70
e	0.68 BSC		
L	0.225	0.25	0.275
N	3		
aaa	0.08		
bbb	0.10		

- NOTES:
 1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).

Land Pattern - SLP1006N3T



DIMENSIONS	
DIM	MILLIMETERS
C	(0.45)
G	0.05
P	0.68
X	0.20
Y	0.40
Z	0.85

- NOTES:
 1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).
 2. THIS LAND PATTERN IS FOR REFERENCE PURPOSES ONLY.
 CONSULT YOUR MANUFACTURING GROUP TO ENSURE YOUR COMPANY'S MANUFACTURING GUIDELINES ARE MET.

PROTECTION PRODUCTS

Marking Code



Ordering Information

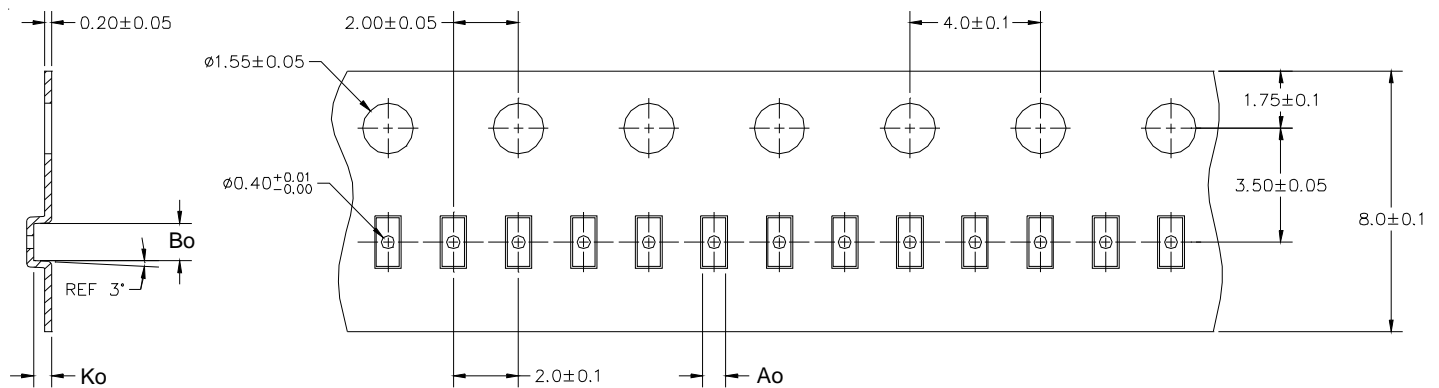
Part Number	Qty per Reel	Reel Size
RClamp0552T.TNT	10,000	7 Inch

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Notes:

Marking will also include line matrix date code

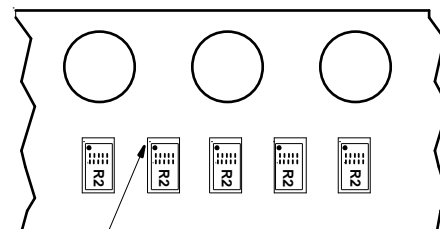
Carrier Tape Specification



A0	B0	K0
0.70 +/-0.05 mm	1.15 +/-0.05 mm	0.55 +/-0.05 mm

Note: All dimensions in mm unless otherwise specified

Device Orientation in Tape



Pin 1 Location
(Towards Sprocket Holes)

Contact Information

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 200 Flynn Rd., Camarillo, CA 93012
 Phone: (805)498-2111 FAX (805)498-3804